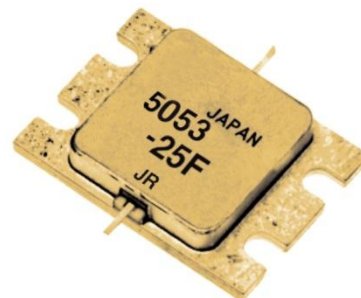


### FEATURES

- High Output Power:  $P_{1dB} = 44.5\text{dBm}$  (Typ.)
- High Gain:  $G_{1dB} = 8.5\text{dB}$  (Typ.)
- High PAE:  $\eta_{add} = 39\%$  (Typ.)
- Low IM3 =  $-46\text{dBc}@P_o = 33.5\text{dBm}$
- Broad Band: 5.0 to 5.3GHz
- Impedance Matched  $Z_{in}/Z_{out} = 50\text{ohm}$



### DESCRIPTION

The FLM5053-25F is a power GaAs FET that is internally matched for standard communication bands to provide optimum power and gain in a 50 ohm system.

SEDI's stringent Quality Assurance Program assures the highest reliability and consistent performance.

### ABSOLUTE MAXIMUM RATING (Ambient Temperature $T_a=25\text{deg.C}$ )

Item	Symbol	Condition	Rating	Unit
Drain-Source Voltage	$V_{DS}$		15	V
Gate-Source Voltage	$V_{GS}$		-5	V
Total Power Dissipation	$P_T$	$T_c = 25\text{deg.C}$	93.7	W
Storage Temperature	$T_{stq}$		-65 to +175	deg.C
Channel Temperature	$T_{ch}$		175	deg.C

SEDI recommends the following conditions for the reliable operation of GaAs FETs:

1. The drain-source operating voltage ( $V_{DS}$ ) should not exceed 10 volts.
2. The forward and reverse gate currents should not exceed 64.0 and -11.2 mA respectively with gate resistance of 25ohm.

### ELECTRICAL CHARACTERISTICS (Ambient Temperature $T_a=25\text{deg.C}$ )

Item	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
Saturated Drain Current	$I_{DSS}$	$V_{DS}=5V, V_{GS}=0V$	-	11.6	17.4	A
Transconductance	$g_m$	$V_{DS}=5V, I_{DS}=6800\text{mA}$	-	5800	-	mS
Pinch-off Voltage	$V_p$	$V_{DS}=5V, I_{DS}=600\text{mA}$	-1.0	-2.0	-3.5	V
Gate Source Breakdown Voltage	$V_{GSO}$	$I_{GS}=-600\text{uA}$	-5.0	-	-	V
Output Power at 1dB G.C.P.	$P_{1dB}$	$V_{DS}=10V,$	43.5	44.5	-	dBm
Power Gain at 1dB G.C.P.	$G_{1dB}$	$I_{DS}=0.55 I_{DSS}$ (Typ.),	7.5	8.5	-	dB
Drain Current	$I_{dsr}$	$f=5.0$ to $5.3$ GHz,	-	6200	7600	mA
Power-added Efficiency	$\eta_{add}$	$Z_S=Z_L=50\text{ohm}$	-	39	-	%
Gain Flatness	$\Delta G$		-	-	+/-0.6	dB
3rd Order Intermodulation Distortion	$IM_3$	$f = 5.3$ GHz, $\Delta f = 10$ MHz 2-Tone Test $P_{out} = 33.5\text{dBm}$ S.C.L.	-44	-46	-	dBc
Thermal Resistance	$R_{th}$	Channel to Case	-	1.4	1.6	deg.C/W
Channel Temperature Rise	$\Delta T_{ch}$	$10V \times I_{dsr} \times R_{th}$	-	-	100	deg.C

G.C.P.: Gain Compression Point, S.C.L.: Single Carrier Level

### CASE STYLE

IK

### ESD

Class 3A

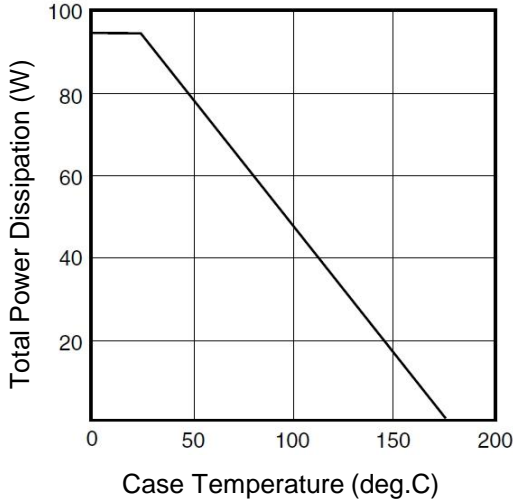
4000V to 8000V

Note : Based on EIAJ ED-4701 C-111A (C=100pF, R=1.5kohm)

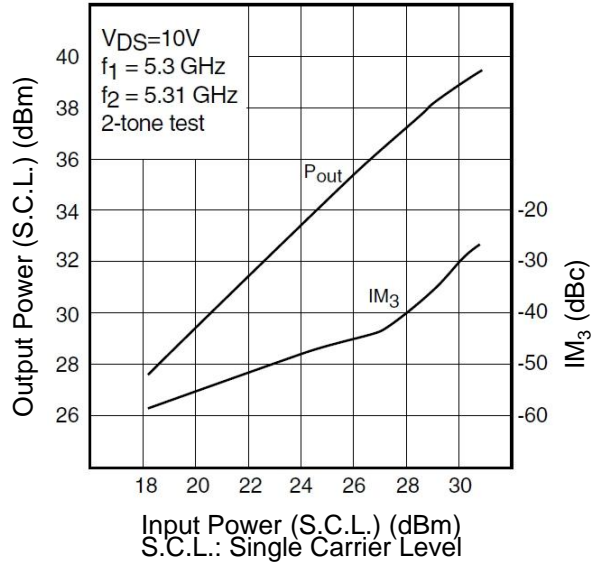
### RoHS Compliance

Yes

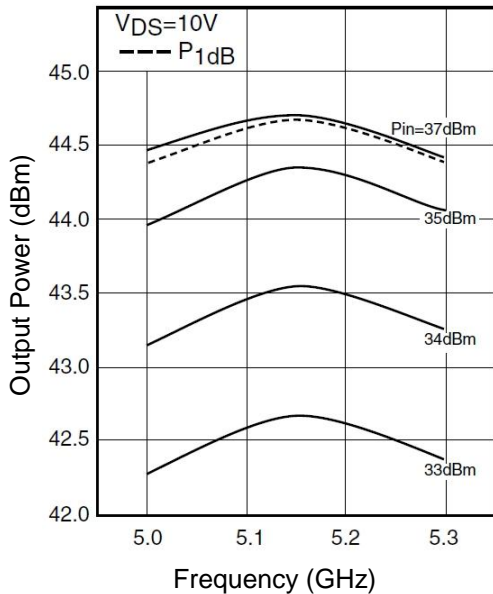
**POWER DERATING CURVE**



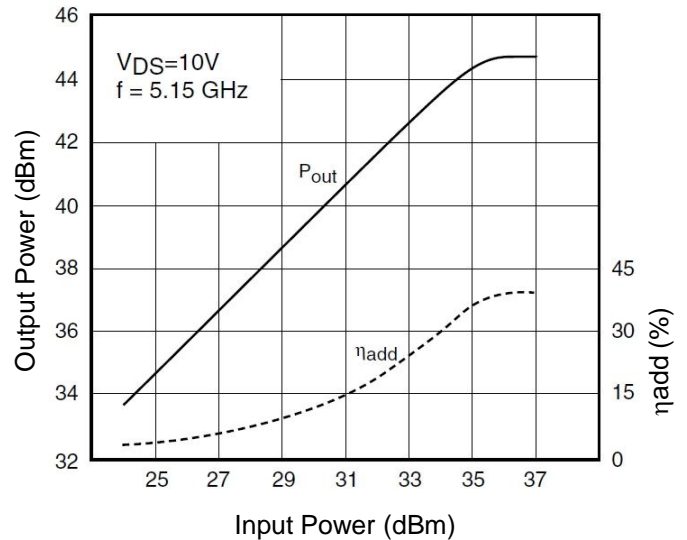
**OUTPUT POWER & IM<sub>3</sub> vs. INPUT POWER**

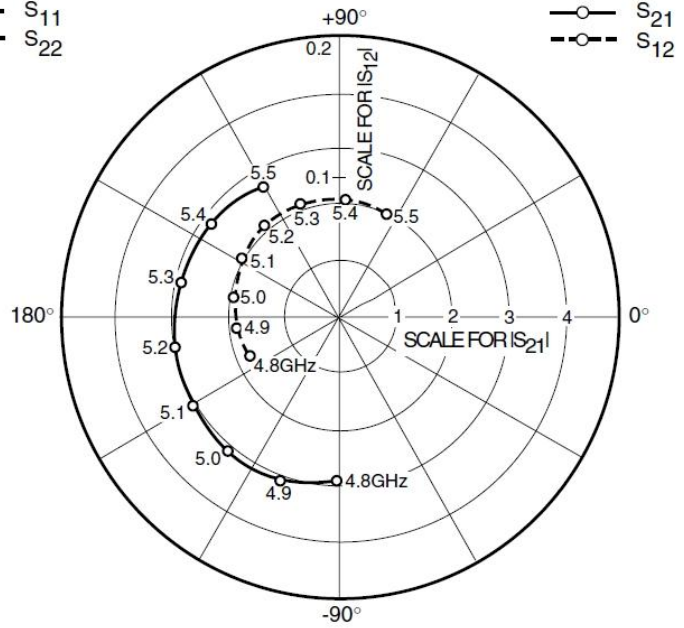
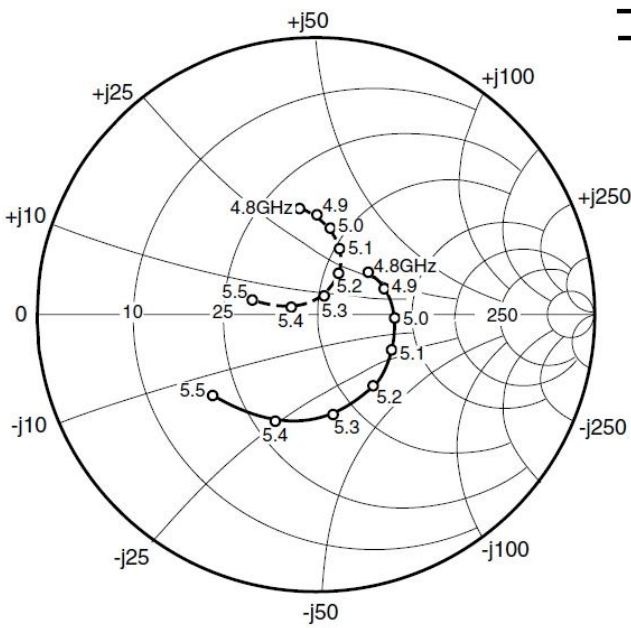


**OUTPUT POWER vs. FREQUENCY**



**OUTPUT POWER, η<sub>add</sub> vs. INPUT POWER**



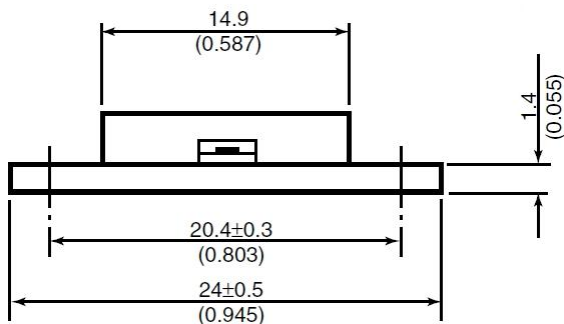
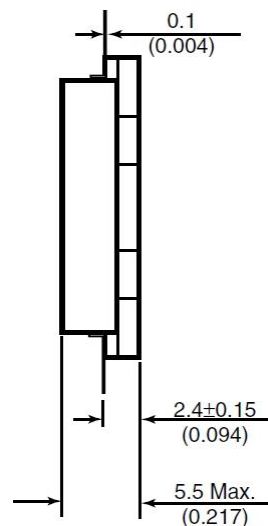
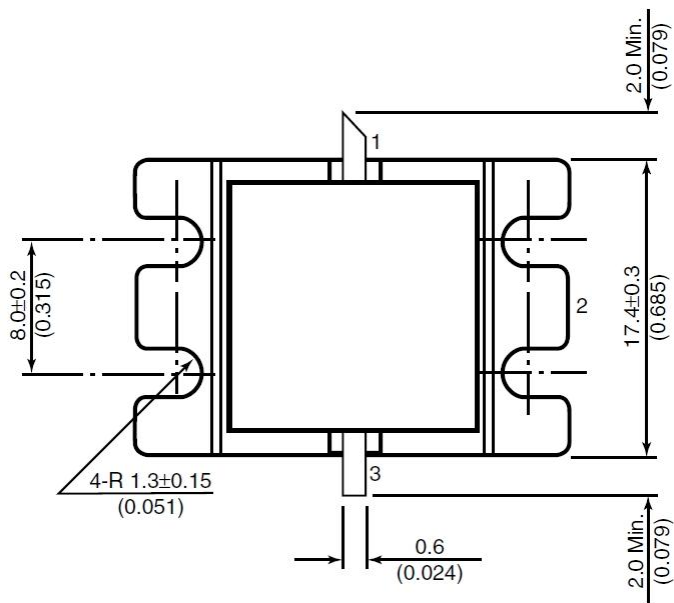


### S-PARAMETERS

$V_{DS} = 10V, I_{DS} = 6800mA$

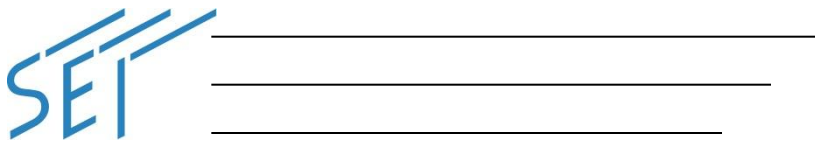
FREQUENCY (MHz)	S11		S21		S12		S22	
	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
4800	0.239	37.6	2.884	-92.0	0.070	-155.8	0.381	99.0
4900	0.258	17.9	3.143	-110.7	0.076	-174.0	0.358	88.4
5000	0.284	-5.6	3.096	-129.9	0.078	169.1	0.314	78.5
5100	0.306	-27.2	3.059	-149.5	0.082	150.1	0.247	68.2
5200	0.344	-52.9	3.023	-170.3	0.084	130.7	0.166	58.1
5300	0.375	-80.6	2.966	168.0	0.085	109.7	0.067	64.5
5400	0.425	-110.2	2.844	144.6	0.083	86.9	0.090	167.2
5500	0.471	-141.4	2.636	120.9	0.079	64.5	0.239	169.8

**Case Style "IK"**  
**Metal-Ceramic Hermetic Package**



- 1. Gate
- 2. Source (Flange)
- 3. Drain

Unit: mm(inches)



**FLM5053-25F**  
**C-Band Internally Matched FET**

**For further information please contact:**

**<http://global-sei.com/Electro-optic/about/office.html>**

**CAUTION**

This product contains **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

- Do not put these products into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.